SWITCHMODE[™] **Power Rectifier Dual Schottky Rectifier**

Features and Benefits

- Low Forward Voltage
- Low Power Loss/High Efficiency
- High Surge Capacity
- 175°C Operating Junction Temperature
- 20 A Total (10 A Per Diode Leg)
- Pb-Free Package is Available

Applications

- Power Supply Output Rectification
- Power Management
- Instrumentation

Mechanical Characteristics

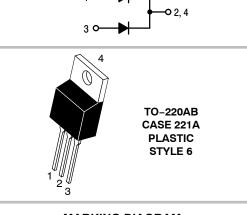
- Case: Epoxy, Molded
- Epoxy Meets UL 94, V-0 @ 0.125 in
- Weight: 1.9 Grams (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperatures for Soldering Purposes: 260¿C Max. for 10 Seconds
- ESD Rating: Human Body Model 3B Machine Model C



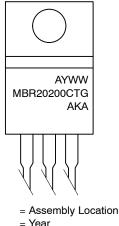
ON Semiconductor®

http://onsemi.com





MARKING DIAGRAM



=	Year	-
_	Work	Wook

А

Y

AKA

WW	= Work Week
G	= Pb-Free Package

= Diode Polarity

ORDERING INFORMATION

Device	Package	Shipping
MBR20200CT	TO-220	50 Units / Rail
MBR20200CTG	TO–220 (Pb–Free)	50 Units / Rail

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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Publication Order Number: MBR20200CT/D

MAXIMUM RATINGS (Per Leg)

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	200	V
Average Rectified Forward Current (T _C = 161°C) Per Leg Per Package	I _{F(AV)}	10 20	A
Peak Repetitive Forward Current per Leg (Square Wave, 20 kHz, T_C = 158°C)	I _{FRM}	20	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I _{FSM}	150	A
Peak Repetitive Reverse Surge Current (2.0 µs, 1.0 kHz)	I _{RRM}	1.0	А
Storage Temperature Range	T _{stg}	-65 to +175	°C
Operating Junction Temperature	Т _Ј	–65 to +175	°C
Voltage Rate of Change (Rated V _R)	dv/dt	10,000	V/μs

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

THERMAL CHARACTERISTICS

Characteristic	Condition	Symbol	Value	Unit
Maximum Thermal Resistance, Junction-to-Case	Minimum Pad	$R_{\theta JC}$	2.0	°C/W
Maximum Thermal Resistance, Junction-to-Ambient	Minimum Pad	$R_{\theta JA}$	60.0	°C/W

ELECTRICAL CHARACTERISTICS (Per Leg)

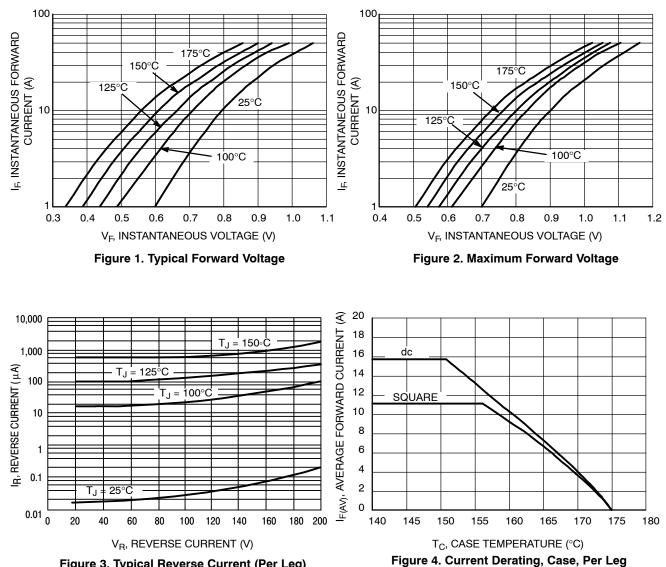
Characteristic	Symbol	Min	Typical	Max	Unit
$ \begin{array}{l} \mbox{Maximum Instantaneous Forward Voltage (Note 1)} & (I_F = 10 \mbox{ A}, T_J = 25^\circ C) \\ & (I_F = 10 \mbox{ A}, T_J = 125^\circ C) \\ & (I_F = 20 \mbox{ A}, T_J = 25^\circ C) \\ & (I_F = 20 \mbox{ A}, T_J = 125^\circ C) \\ & (I_F = 20 \mbox{ A}, T_J = 125^\circ C) \end{array} $	VF	- - -	0.80 0.66 0.89 0.76	0.90 0.80 1.00 0.90	V
Maximum Instantaneous Reverse Current (Note 1) (Rated dc Voltage, T _J = 25°C) (Rated dc Voltage, T _J = 125°C)	I _R	-	0.0002 0.4	1.0 50	mA

DYNAMIC CHARACTERISTICS (Per Leg)

Characteristic	Symbol	Value	Unit
Capacitance (V _R = -5.0 V, T _C = 25° C, Frequency = 1.0 MHz)	CT	500	pF

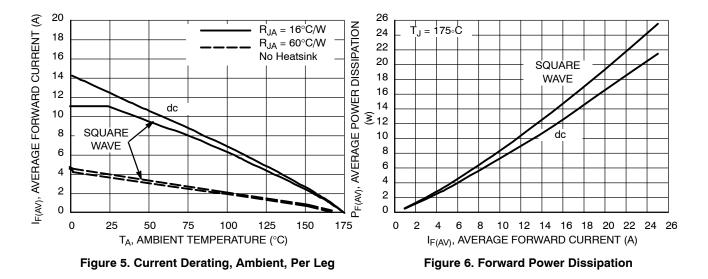
1. Pulse Test: Pulse Width = 300 $\mu s,$ Duty Cycle \leq 2.0%.

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www.BDhtp://hsmi.comcom/



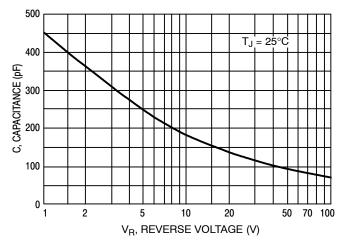


Figure 7. Typical Capacitance (Per Leg)

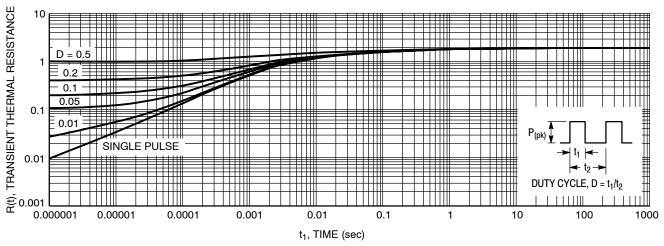
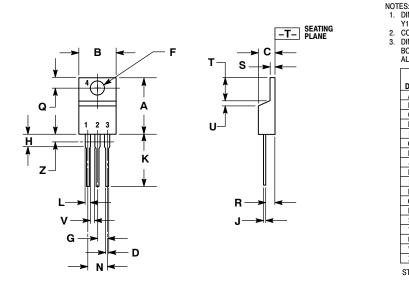


Figure 8. Thermal Response Junction-to-Case

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PACKAGE DIMENSIONS

TO-220 CASE 221A-09 **ISSUE AF**



	INCHES		MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.570	0.620	14.48	15.75	
В	0.380	0.405	9.66	10.28	
С	0.160	0.190	4.07	4.82	
D	0.025	0.035	0.64	0.88	
F	0.142	0.161	3.61	4.09	
G	0.095	0.105	2.42	2.66	
Н	0.110	0.155	2.80	3.93	
J	0.014	0.025	0.36	0.64	
Κ	0.500	0.562	12.70	14.27	
L	0.045	0.060	1.15	1.52	
Ν	0.190	0.210	4.83	5.33	
Q	0.100	0.120	2.54	3.04	
R	0.080	0.110	2.04	2.79	
S	0.045	0.055	1.15	1.39	
Т	0.235	0.255	5.97	6.47	
U	0.000	0.050	0.00	1.27	
۷	0.045		1.15		
Ζ		0.080		2.04	

4. CATHODE

DIMENSIONING AND TOLERANCING PER ANSI

CONTROLLING DIMENSION: INCH.

Y14.5M. 1982.

3.

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